



Description

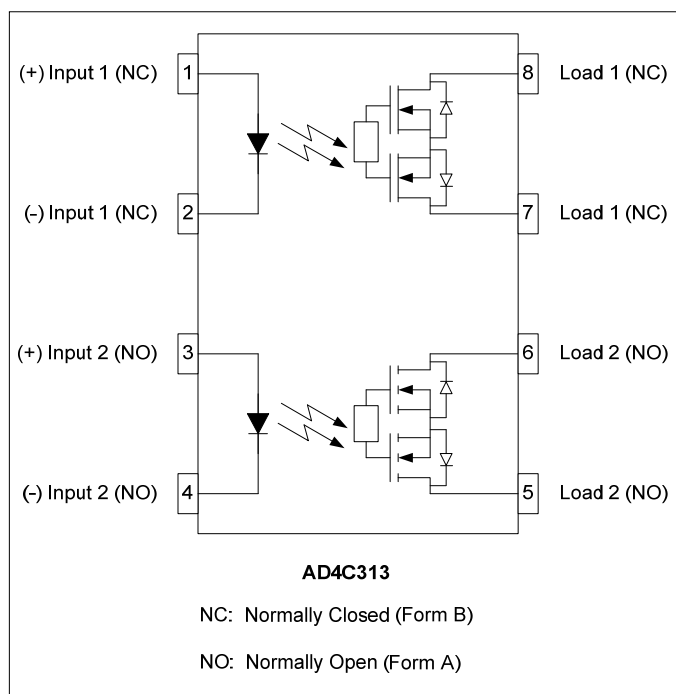
The AD4C313 is composed of two isolated relays; one normally open and one normally closed. Each relay has a bi-directional, single-pole, single-throw contact. Completely independent of its counterpart, each consists of an LED driver that activates an integrated circuit, which in turn drives a pair of DMOS transistors. These transistors are protected with free-wheeling diodes that can handle up to 1.5A of inrush current, making the relay ideal for switching lamps and highly inductive loads.

The AD4C313 comes standard in a compact 8 pin DIP package making it ideal for high-density board applications.

Applications

- Meter Reading Systems
- Multiplexers
- Data Acquisition
- Medical Equipment
- Battery Monitoring
- Home / Safety Security Systems

Schematic Diagram



Features

- 1 Form A / 1 Form B Integrated in Single Package
- Low Input Control Current (2.5mA TYP)
- 180mA Maximum Continuous Load Current
- Low On Resistance (15 Ω MAX)
- High Isolation Voltage (up to 5kV_{RMS})
- Long Life / High Reliability
- RoHS / Pb-Free / REACH Compliant

Agency Approvals

UL/C-UL: File # E201932
VDE: File # 40035191 (EN 60747-5-2)

Absolute Maximum Ratings

The values indicated are absolute stress ratings. Functional operation of the device is not implied at these or any conditions in excess of those defined in electrical characteristics section of this document. Exposure to absolute Maximum Ratings may cause permanent damage to the device and may adversely affect reliability.

Storage Temperature-55 to +125°C
Operating Temperature-40 to +85°C
Continuous Input Current.....50mA
Transient Input Current.....500mA
Reverse Input Control Voltage5V
Input Power Dissipation.....40mW
Output Power Dissipation800mW
Solder Temperature – Wave (10sec).....260°C
Solder Temperature – IR Reflow (10sec).....260°C

Ordering Information

Part Number	Description
AD4C313	8 pin DIP, (50/Tube)
AD4C313-H	5kV _{RMS} Viso, 8 pin DIP, (50/Tube)
AD4C313-S	8 pin SMD, (50/Tube)
AD4C313-HS	5kV _{RMS} , 8 pin SMD, (50/Tube)
AD4C313-STR	8 pin SMD, Tape and Reel (1000/Reel)
AD4C313-HSTR	5kV _{RMS} , 8 pin SMD, Tape and Reel (1000/Reel)

NOTE: Suffixes listed above are not included in marking on device for part number identification

Electrical Characteristics, $T_A = 25^\circ\text{C}$ (unless otherwise specified)

Parameter	Symbol	Min.	Typ.	Max.	Units	Test Conditions
Input Specifications						
LED Forward Voltage	V_F	-	1.2	1.5	V	$I_F = 10\text{mA}$
LED Reverse Voltage	BV_R	5	-	-	V	$I_R = 10\mu\text{A}$
Turn-On Current (Form A – Normally Open)	$I_{F(NO)}$	-	2.5	5	mA	$I_O = 180\text{mA}$
Turn-On Current (Form B – Normally Closed)	$I_{F(NC)}$	-	0.5	-	mA	$I_O = 180\text{mA}$
Turn-Off Current (Form A – Normally Open)	$I_{OFF(NO)}$	-	0.5	-	mA	$I_O = 180\text{mA}$
Turn-Off Current (Form B – Normally Open)	$I_{OFF(NC)}$	-	2.5	5	mA	$I_O = 180\text{mA}$
Output Specifications – Form A (Normally Open)						
Blocking Voltage	V_B	400	-	-	V	$I_O = 1\mu\text{A}$
Continuous Load Current	I_O	-	-	180	mA	$I_F = 5\text{mA}$
On Resistance	R_{ON}	-	12	15	Ω	$I_F = 5\text{mA}, I_O = 180\text{mA}$
Leakage Current	I_{Oleak}	-	0.2	1	μA	$I_F = 0\text{mA}, V_O = 400\text{V}$
Output Capacitance	C_{OUT}	-	25	-	pF	$V_O = 25\text{V}, f = 1.0\text{MHz}$
Offset Voltage	V_{OFFSET}	-	-	0.2	mV	$I_F = 5\text{mA}$
Turn-On Time	T_{ON}	-	2	5	mS	$I_F = 5\text{mA}, I_O = 180\text{mA}$
Turn-Off Time	T_{OFF}	-	0.05	5	mS	$I_F = 0\text{mA}, I_O = 180\text{mA}$
Output Specifications – Form B (Normally Closed)						
Blocking Voltage	V_B	400	-	-	V	$I_F = 5\text{mA}, I_O = 1\mu\text{A}$
Continuous Load Current	I_O	-	-	180	mA	$I_F = 0\text{mA}$
On Resistance	R_{ON}	-	12	15	Ω	$I_F = 0\text{mA}, I_O = 180\text{mA}$
Leakage Current	I_{Oleak}	-	0.2	1	μA	$I_F = 5\text{mA}, V_O = 400\text{V}$
Output Capacitance	C_{OUT}	-	25	-	pF	$I_F = 5\text{mA}, f = 1.0\text{MHz}$
Offset Voltage	V_{OFFSET}	-	-	0.2	mV	$I_F = 0\text{mA}$
Turn-On Time	T_{ON}	-	0.1	5	mS	$I_F = 0\text{mA}, I_O = 180\text{mA}$
Turn-Off Time	T_{OFF}	-	2	5	mS	$I_F = 5\text{mA}, I_O = 180\text{mA}$
Coupled Specifications						
Coupled Capacitance	$C_{COUPLED}$	-	3	-	pF	
Contact Transient Ratio	-	2,000	7,000	0	V/ μS	dV = 50V
Isolation Specifications						
Isolation Voltage (-H Option)	V_{ISO}	3750 5000	- -	- -	V_{RMS}	$RH \leq 50\%, t = 1\text{min}$
Input-Output Resistance	R_{I-O}	-	10^{12}	-	Ω	$V_{I-O} = 500V_{DC}$

AD4C313 Performance & Characteristics Plots, $T_A = 25^\circ\text{C}$ (unless otherwise specified)

Figure 1: Normally Open
Typical Turn-On Time Distribution
(N = 100, $T_a = 25^\circ\text{C}$)

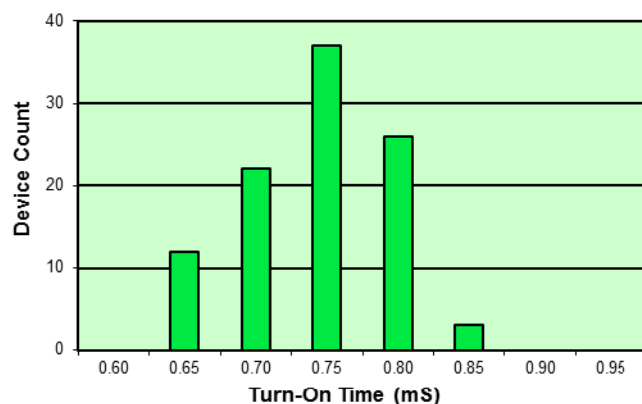


Figure 2: Normally Open
Typical Turn-Off Time Distribution
(N = 100, $T_a = 25^\circ\text{C}$)

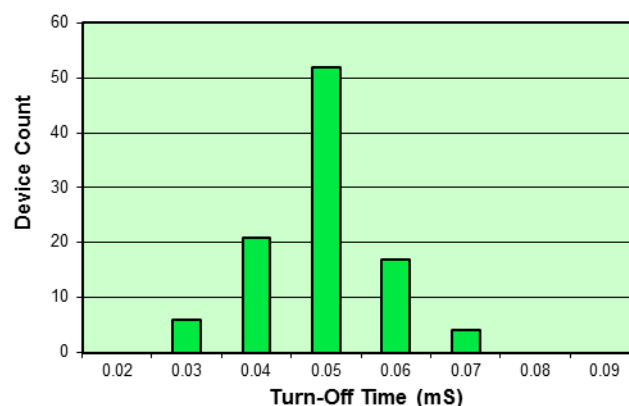


Figure 3: Normally Open
Typical On-Resistance Distribution
(N = 100, $T_a = 25^\circ\text{C}$)

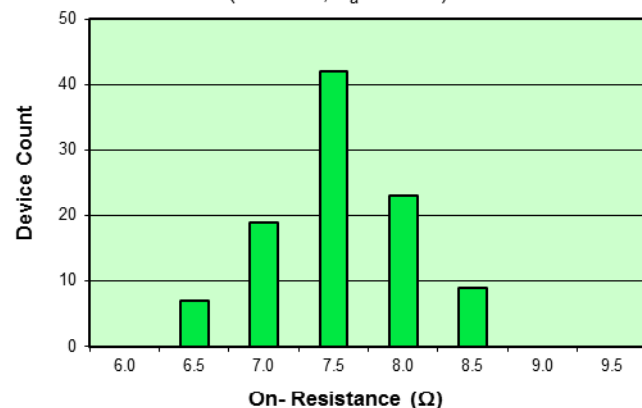


Figure 4: Normally Open
Typical Output Leakage Current Distribution
(N = 100, $T_a = 25^\circ\text{C}$)

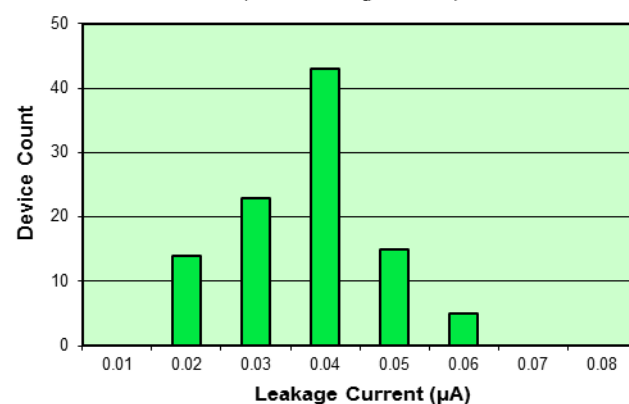


Figure 5: Normally Open
Typical Blocking Voltage Distribution
(N = 100, $T_a = 25^\circ\text{C}$)

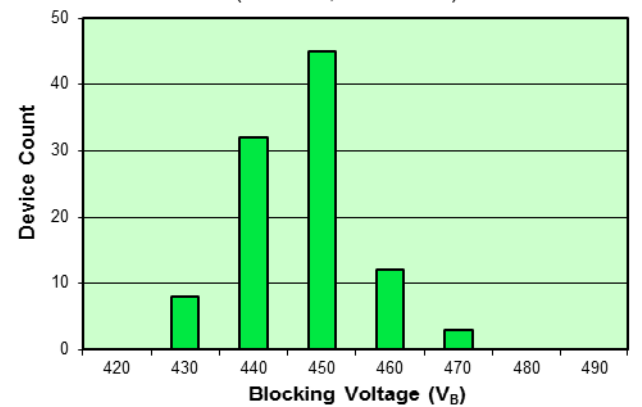
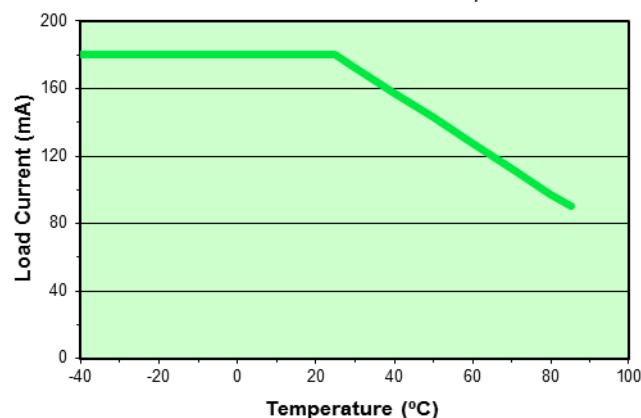


Figure 6: Normally Open
Maximum Load Current vs. Temperature



AD4C313 Performance & Characteristics Plots, Cont... $T_A = 25^\circ\text{C}$ (unless otherwise specified)

Figure 7: Normally Closed
Typical Turn-On Time Distribution
(N = 100, $T_a = 25^\circ\text{C}$)

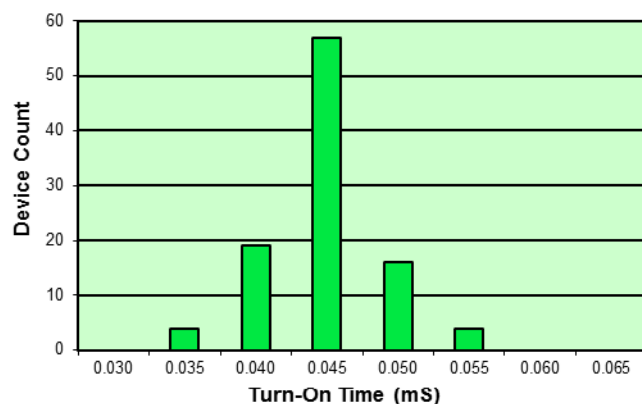


Figure 8: Normally Closed
Typical Turn-Off Time Distribution
(N = 100, $T_a = 25^\circ\text{C}$)

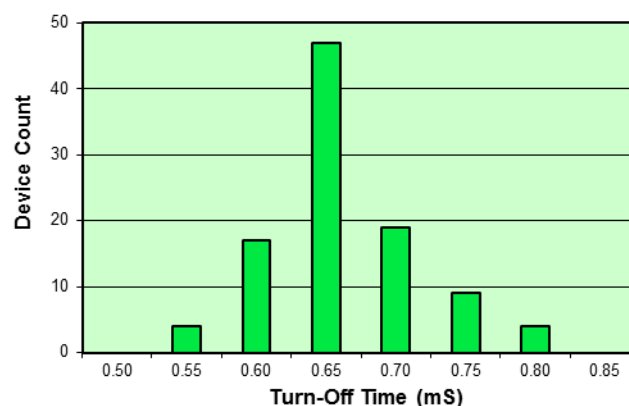


Figure 9: Normally Closed
Typical On-Resistance Distribution
(N = 100, $T_a = 25^\circ\text{C}$)

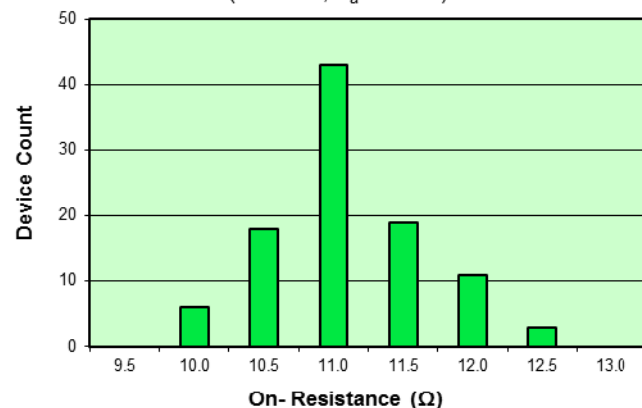


Figure 10: Normally Closed
Typical Output Leakage Current Distribution
(N = 100, $T_a = 25^\circ\text{C}$)

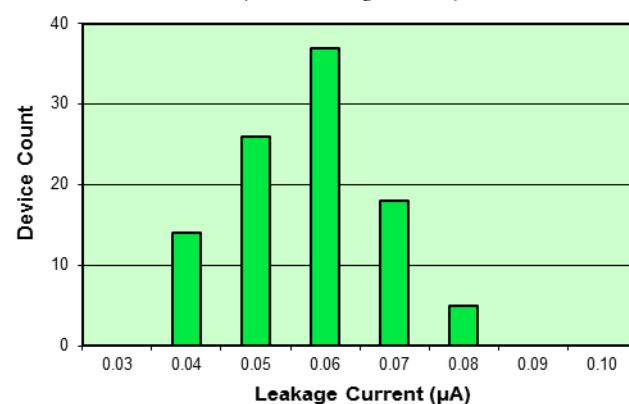


Figure 11: Normally Closed
Typical Blocking Voltage Distribution
(N = 100, $T_a = 25^\circ\text{C}$)

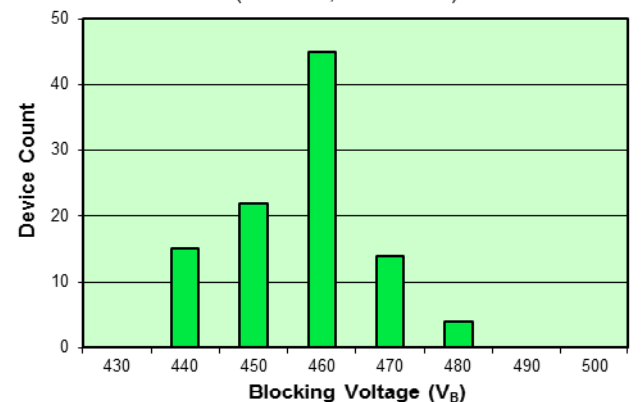
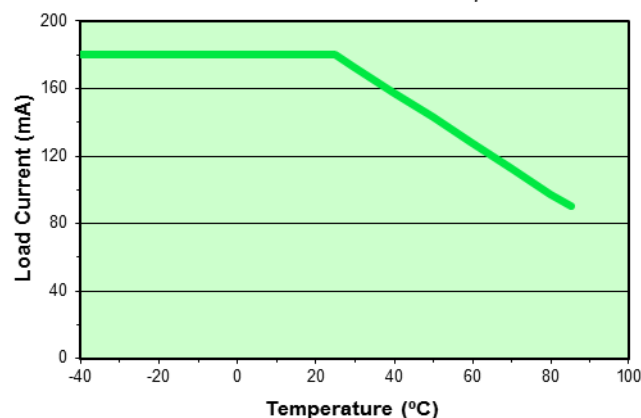


Figure 12: Normally Closed
Maximum Load Current vs. Temperature



AD4C313 Solder Temperature Profile Recommendations

(1) Infrared Reflow:

Refer to the following figure as an example of an optimal temperature profile for single occurrence infrared reflow. Soldering process should not exceed temperature or time limits expressed herein. Surface temperature of device package should not exceed 250°C:

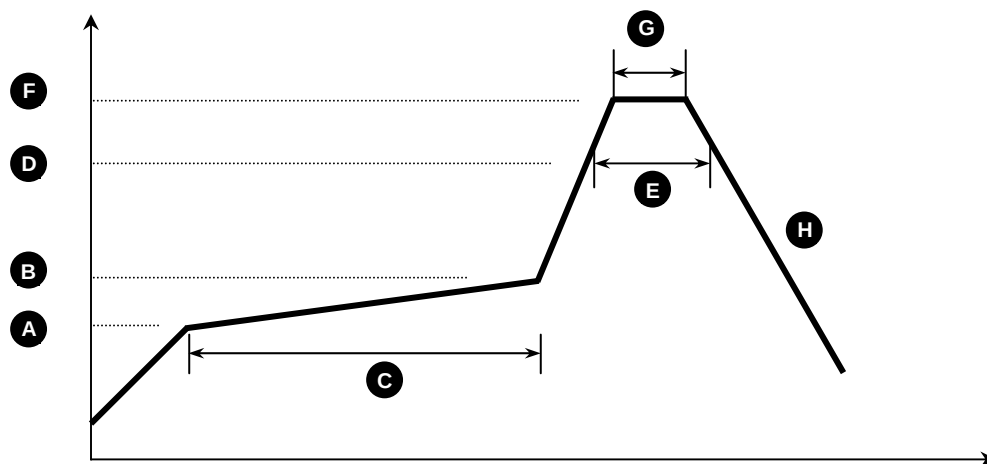


Figure 1

Process Step	Description	Parameter
A	Preheat Start Temperature (°C)	150°C
B	Preheat Finish Temperature (°C)	180°C
C	Preheat Time (s)	90 - 120s
D	Melting Temperature (°C)	230°C
E	Time above Melting Temperature (s)	30s
F	Peak Temperature, at Terminal (°C)	260°C
G	Dwell Time at Peak Temperature (s)	10s
H	Cool-down (°C/s)	<6°C/s

(2) Wave Solder:

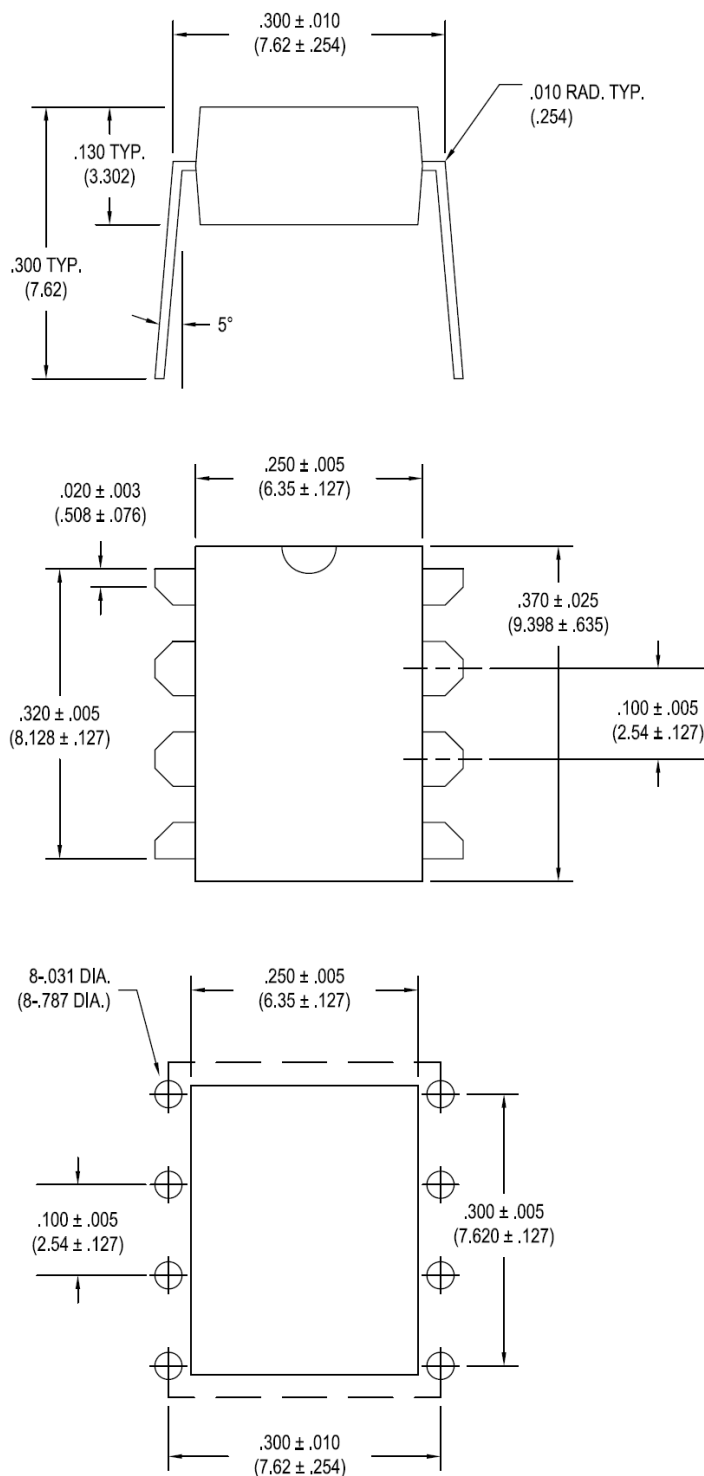
Maximum Temperature: 260°C (at terminal)
Maximum Time: 10s
Pre-heating: 100 - 150°C (30 - 90s)
Single Occurrence

(3) Hand Solder:

Maximum Temperature: 350°C (at tip of soldering iron)
Maximum Time: 3s
Single Occurrence

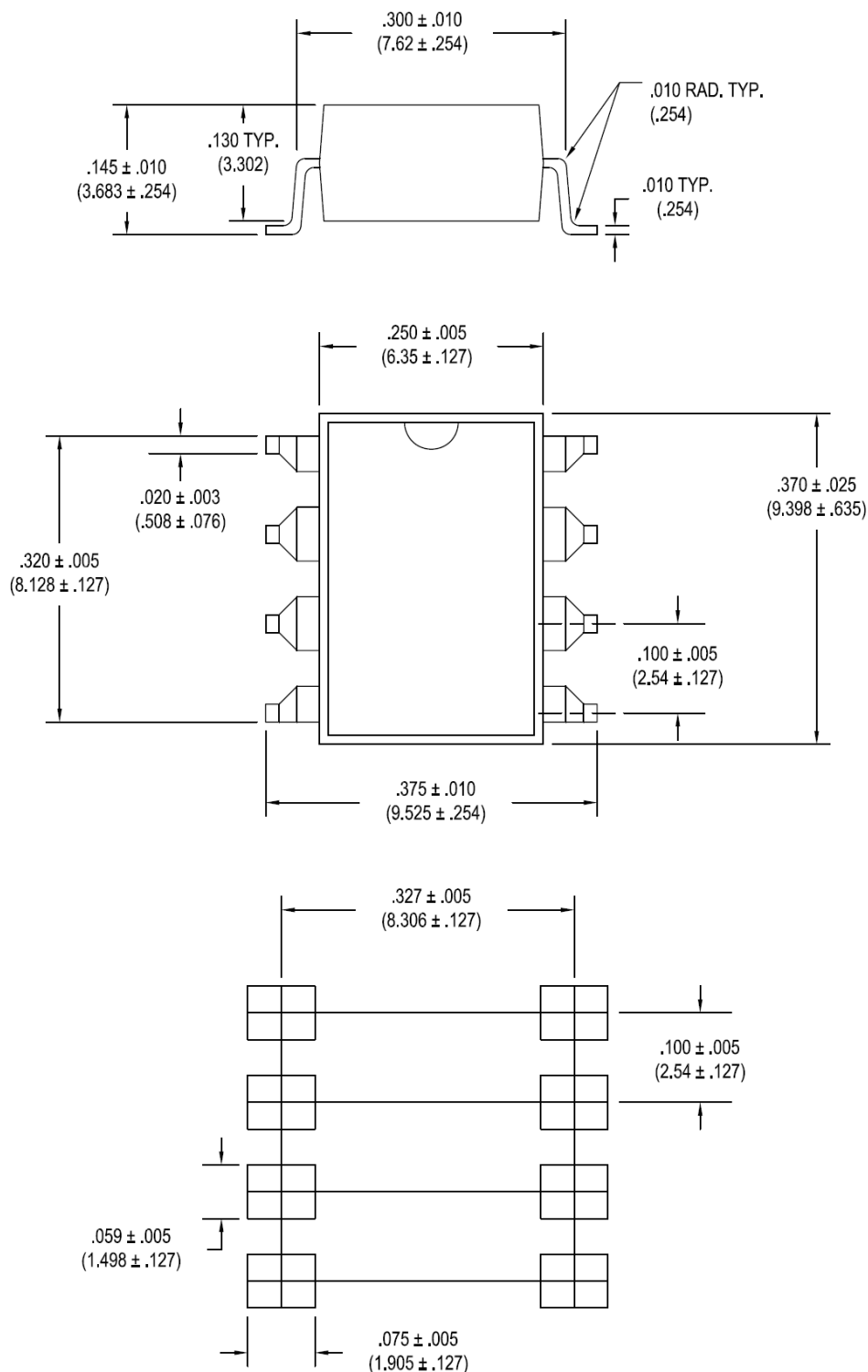
AD4C313 Package Dimensions

8 PIN DIP Package

Note: All dimensions in inches ["] with millimeters in parenthesis ()


AD4C313 Package Dimensions

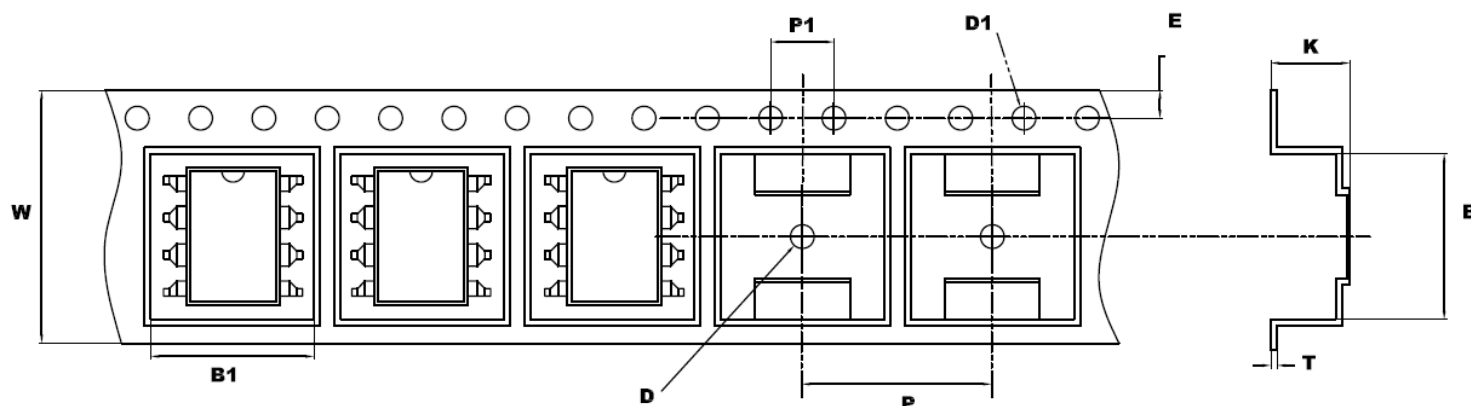
8 PIN SMD Surface Mount Package (-S)

Note: All dimensions in inches ["] with millimeters in parenthesis ()


AD4C313 Package Dimensions

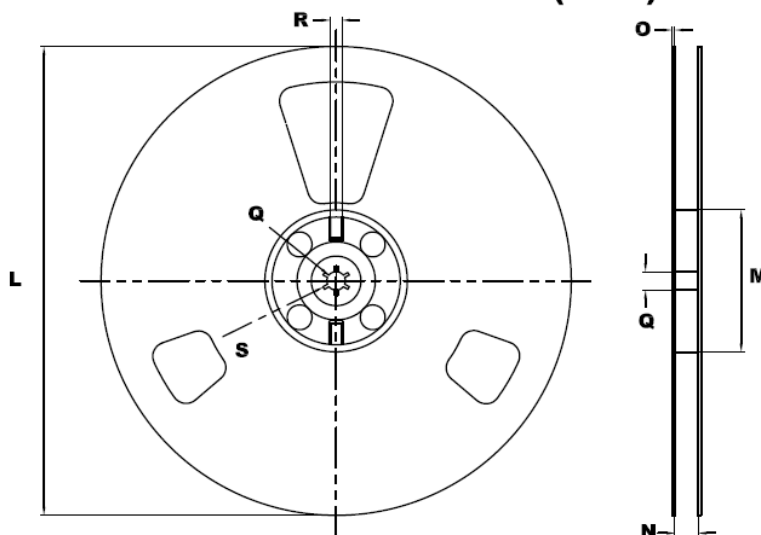
8 PIN SMD Tape & Reel (-STR)

Note: All dimensions in millimeters

Outline and Dimension (Tape)


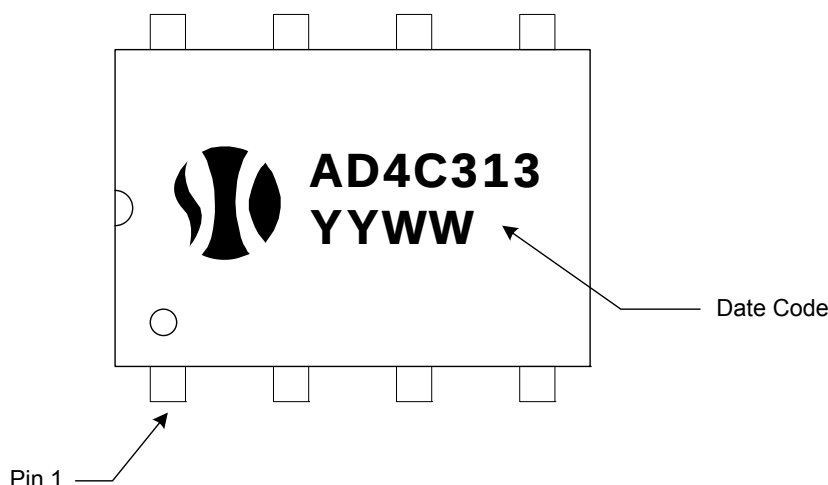
Direction of Feed

W	B	B1	P	P1	K	E	T	D	D1
16.00 ± 0.1	10.50 ± 0.1	10.30 ± 0.1	12.00 ± 0.1	4.00 ± 0.1	5.00 ± 0.1	1.75 ± 0.1	0.40 ± 0.1	1.50 ± 0.1	1.50 ± 0.1

Outline and Dimensions (Reel)

Packaging: 1,000 pcs / reel

L	M	N	O	Q	R	S
330.00	100.00	16.40 ± 0.2	2.00 ± 0.1	13.00 ± 0.2	2.00	10.00

AD4C313 Package Marking



AD4C313 Package Weights

Device	Single Unit	Full Tube (50pcs)	Full Pouch (10 tubes)	Full Reel (1000pcs)
AD4C313-(H)	0.54	42	420	-
AD4C313-(H)S	0.53	44	440	-
AD4C313-(H)STR	0.53	-	-	950

Note: All weights above are in GRAMS, and include packaging materials where applicable

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